

### **Transient Voltage Suppressors for ESD Protection**

### **General Description**

The LESD5.0T1G is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium.

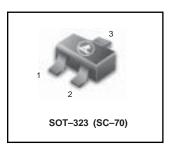
### **Applications**

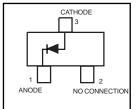
- Cellular phones
- Portable devices
- Digital cameras
- Power supplies

### **Features**

- Small Body Outline Dimensions
- Low Body Height
- Stand-off Voltage: 2.5 V 7.0 V
- Peak Power up to 200 Watts @ 8 x 20 s Pulse
- Low Leakage
- Response Time is Typically < 1 ns
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- IEC61000-4-2 Level 4 ESD Protection
- IEC61000-4-4 Level 4 EFT Protection
- We declare that the material of product compliance with RoHS requirements.

## LESD5.0T1G





#### **ORDERING INFORMATION**

Device	Package	Shipping		
LESD5.0T1G	SC-70	3000/Tape & Reel		

### Absolute Ratings (T<sub>amb</sub>=25°C)

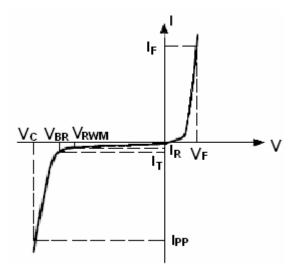
Symbol	Parameter	Value	Units
P <sub>PP</sub>	Peak Pulse Power (t <sub>p</sub> = 8/20μs)	200	W
TL	Maximum lead temperature for soldering during 10s	260	°C
T <sub>stg</sub>	Storage Temperature Range	-55 to +150	°C
T <sub>op</sub>	Operating Temperature Range	-40 to +125	°C
T <sub>j</sub>	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD) air discharge contact discharge	±15 ±8	KV
	IEC61000-4-4 (EFT)	40	Α
	ESD Voltage Per Human Body Model	16	KV



# LESD5.0T1G

### **Electrical Parameter**

Symbol	Parameter					
$I_{PP}$	Maximum Reverse Peak Pulse Current					
V <sub>C</sub>	Clamping Voltage @ I <sub>PP</sub>					
$V_{RWM}$	Working Peak Reverse Voltage					
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>					
I <sub>T</sub>	Test Current					
$V_{BR}$	Breakdown Voltage @ I <sub>T</sub>					
I <sub>F</sub>	Forward Current					
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>					



### **Electrical Characteristics** Ratings at 25°C ambient temperature unless otherwise specified.VF = 0.9V at IF = 10mA

Device	V <sub>RWM</sub> (V)	I <sub>R</sub> (uA) @ V <sub>RWM</sub>	V <sub>BR</sub> (V)@ I <sub>T</sub> (Note 1)	I <sub>T</sub>	V <sub>C</sub> (V) @ I <sub>PP</sub> =5 A*	V <sub>C</sub> (V) @ Max I <sub>PP</sub> *	I <sub>PP</sub> (A)*	P <sub>PK</sub> (W)*	C (pF)
	Max	Max	Min	mA	Тур	Max	Max	Max	Тур
LESD5.0T1G	5.0	-1	6.2	1.0	11.6	18.6	9.4	174	50

<sup>\*</sup>Surge current waveform per Figure 1.

<sup>1.</sup>  $V_{BR}$  is measured with a pluse test current  $I_T$  at an ambient temperature of 25  $^{\circ}$ C.



## LESD5.0T1G

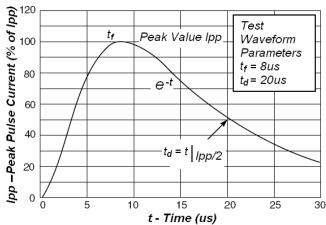


Fig1. Pulse Waveform

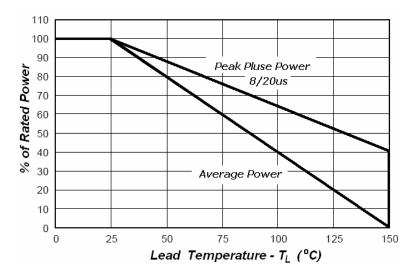


Fig3.Power Derating

### **Application Note**

Electrostatic discharge (ESD) is a major cause of failure in electronic systems. Transient Voltage Suppressors (TVS) are an ideal choice for ESD protection. They are capable of clamping the incoming transient to a low enough level such that damage to the protected semiconductor is prevented.

Surface mount TVS offer the best choice for minimal lead inductance. They serve as parallel protection elements, connected between the signal line to ground. As the transient rises above the operating voltage of the device, the TVS becomes a low impedance path diverting the transient current to ground. The LESD5.0T1G is the ideal board evel protection of ESD sensitive semiconductor components.

The tiny SC70 package allows design flexibility in the design of high density boards where the space saving is at a premium. This enables to shorten the routing and contributes to hardening againt ESD.



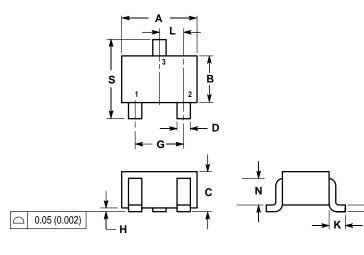
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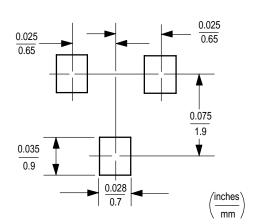
### SC-70/SOT-323

### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.

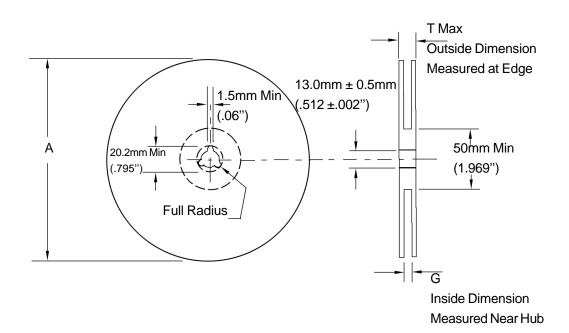
DIM	INC	CHES	MILLIMETERS		
ואוט	MIN	MAX	MIN	MAX	
Α	0.071	0.087	1.80	2.20	
В	0.045	0.053	1.15	1.35	
С	0.032	0.040	0.80	1.00	
D	0.012	0.016	0.30	0.40	
G	0.047	0.055	1.20	1.40	
Н	0.000	0.004	0.00	0.10	
J	0.004	0.010	0.10	0.25	
K	0.017 REF		0.425 REF		
L	0.026 BSC		0.650 BSC		
N	0.028 REF		0.700 REF		
S	0.079	0.095	2.00	2.40	
	B C D G H J K L	MIN A 0.071 B 0.045 C 0.032 D 0.012 G 0.047 H 0.000 J 0.004 K 0.017 L 0.026 N 0.028	MIN MAX A 0.071 0.087 B 0.045 0.053 C 0.032 0.040 D 0.012 0.016 G 0.047 0.055 H 0.000 0.004 J 0.004 0.010 K 0.017 REF L 0.026 BSC N 0.028 REF	DIM   MIN   MAX   MIN   A   0.071   0.087   1.80   B   0.045   0.053   1.15   C   0.032   0.040   0.80   D   0.012   0.016   0.30   G   0.047   0.055   1.20   H   0.000   0.004   0.00   J   0.004   0.010   0.10   K   0.017   REF   0.425   L   0.026   BSC   0.650   N   0.028   REF   0.700   D.004   0.000   D.004   0.000   D.004   0.000   D.004   0.010   D.004   D.006   D	







### **EMBOSSED TAPE AND REEL DATA** FOR DISCRETES



Size	A Max	G	T Max
8 mm	330mm	8.4mm+1.5mm, -0.0	14.4mm
	(12.992")	(.33"+.059", -0.00)	(.56")

#### **Reel Dimensions**

Metric Dimensions Govern — English are in parentheses for reference only

### **Storage Conditions**

Temperature: 5 to 40 Deg.C (20 to 30 Deg. C is preferred) Humidity: 30 to 80 RH (40 to 60 is preferred )

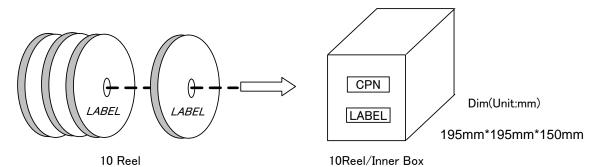
Recommended Period: One year after manufacturing

(This recommended period is for the soldering condition only. The characteristics and reliabilities of the products are not restricted to

this limitation)

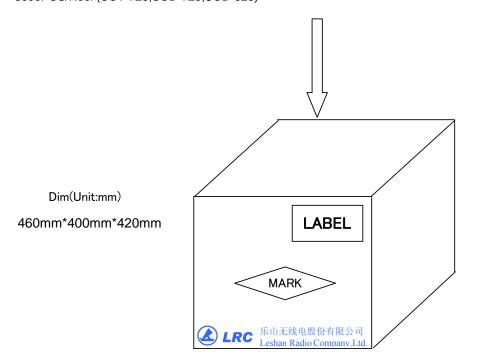


## **Shipment Specification**



3000PCS/Reel 8000PCS/Reel (SOT-723,SOD-723,SOD-923)

30KPCS/Inner Box 80KPCS/Inner Box (SOT-723,SOD-723,SOD-923)



12 Inner Box/Carton

360KPCS/Carton 960KPCS/Carton (SOT-723,SOD-723,SOD-923)